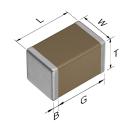
积层贴片陶瓷片式电容器

C2012X5R1H475M125AB

RoHS Reach Halogen Free Pb Free

交货型号	C2012X5R1H475MT****	
用途	一般等级 车载用途时为 <u>CGA4J3X5R1H475M125AB</u> 。	
特点	General 一般(~75V)	
系列	C2012 [EIA 0805]	
状态	↑ 量产体制(新设计非推荐) 推荐代替型号 : C2012X5R1H475K125AB (不保证其兼容性。)	



	尺寸
长度(L)	$2.00 \text{mm} \pm 0.20 \text{mm}$
宽度(W)	1.25mm ±0.20mm
厚度(T)	1.25mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)
1世存产益41/四 (FA)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
1年47年3月月1	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
1世行が一連つ1月1日(日日)	0.90mm to 1.20mm(Reflow Soldering)

Ħ	1气特性
电容	$4.7\mu\mathrm{F}\pm20\%$
额定电压	50VDC
温度特性	X5R(±15%)
耗散因数 (Max.)	7.5%
绝缘电阻 (Min.)	106ΜΩ

	其他
焊接方法	流体
件按方法	回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

 $^{! \ \}mbox{All specifications}$ are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

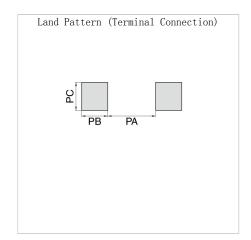
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Associated Images



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